# imall

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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



### 12-Bit Parity Generator-Checker

#### Description

The MC10H160 is a 12-bit parity generator-checker. The output goes high when an odd number of inputs are high providing the odd parity function. Unconnected inputs are pulled to a logic low allowing parity detection and generation for less than 12-bits. The MC10H160 is a functional pin duplication of the standard 10K family part with 100% improvement in propagation delay and no increase in power-supply current.

#### Features

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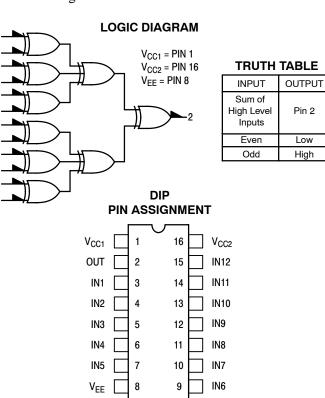
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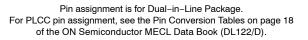
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- Propagation Delay, 2.5 ns Typical
- Power Dissipation, 320 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K<sup>™</sup> Compatible
- Pb-Free Packages are Available\*



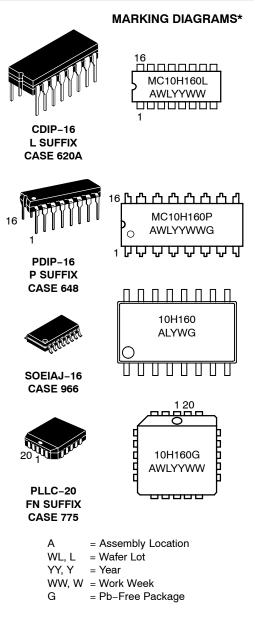


\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



#### **ON Semiconductor®**

http://onsemi.com



\*For additional marking information, refer to Application Note AND8002/D.

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

#### Table 1. MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
$V_{EE}$	Power Supply (V <sub>CC</sub> = 0)	-8.0 to 0	Vdc
VI	Input Voltage (V <sub>CC</sub> = 0)	0 to V <sub>EE</sub>	Vdc
l <sub>out</sub>	Output Current – Continuous – Surge	50 100	mA
T <sub>A</sub>	Operating Temperature Range	0 to +75	°C
T <sub>stg</sub>	Storage Temperature Range – Plastic – Ceramic	−55 to +150 −55 to +165	°C °C

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

#### Table 2. ELECTRICAL CHARACTERISTICS (V<sub>EE</sub> = -5.2 V $\pm 5\%$ ) (Note 1)

		<b>0</b> ° <b>25</b> °		<b>75</b> °				
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
Ι <sub>Ε</sub>	Power Supply Current	-	88	-	78	-	88	mA
l <sub>inH</sub>	Input Current High Pins 3,5,7,10,12,14 Pins 4,6,9,11,13,15		391 457		246 285		246 285	μΑ
I <sub>inL</sub>	Input Current Low	0.5	-	0.5	-	0.3	_	μA
V <sub>OH</sub>	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V <sub>OL</sub>	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V <sub>IH</sub>	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
VIL	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

1. Each MECL 10H<sup>™</sup> series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50 Ω resistor to –2.0 V.

#### Table 3. AC PARAMETERS

		<b>0</b> °		25°		<b>75</b> °		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
t <sub>pd</sub>	Propagation Delay	1.1	3.1	1.1	3.3	1.2	3.5	ns
tr	Rise Time	0.55	1.5	0.55	1.6	0.75	1.7	ns
t <sub>f</sub>	Fall Time	0.55	1.5	0.55	1.6	0.75	1.7	ns

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

#### **ORDERING INFORMATION**

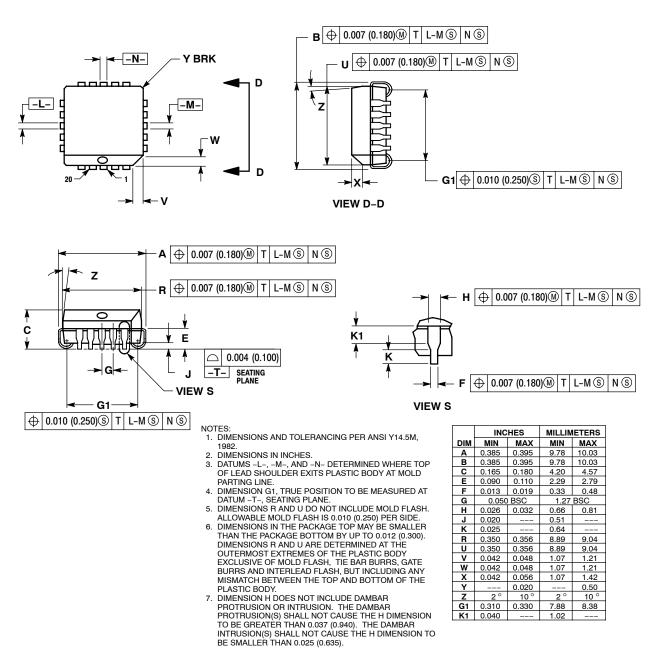
Device	Package	Shipping <sup>†</sup>
MC10H160FN	PLLC-20	46 Units / Rail
MC10H160FNG	PLLC-20 (Pb-Free)	46 Units / Rail
MC10H160L	CDIP-16	25 Unit / Rail
MC10H160M	SOEIAJ-16	50 Unit / Rail
MC10H160MG	SOEIAJ-16 (Pb-Free)	50 Unit / Rail
MC10H160MEL	SOEIAJ-16	2000 / Tape & Reel
MC10H160MELG	SOEIAJ-16 (Pb-Free)	2000 / Tape & Reel
MC10H160P	PDIP-16	25 Unit / Rail
MC10H160PG	PDIP-16 (Pb-Free)	25 Unit / Rail

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### PACKAGE DIMENSIONS

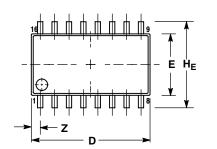


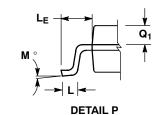
CASE 775-02 ISSUE E

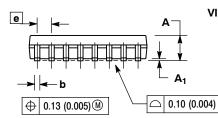


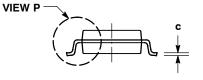
#### PACKAGE DIMENSIONS

#### SOEIAJ-16 CASE 966-01 **ISSUE A**







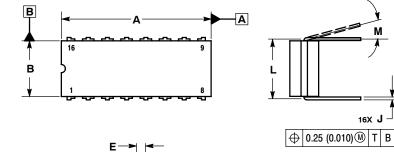


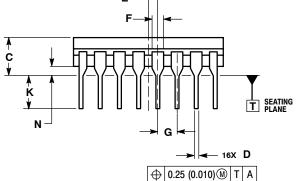
- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI

- NO TES:
  NO TES:
  DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  CONTROLLING DIMENSION: MILLIMETER.
  DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
  THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION ANTERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIN	IETERS	INC	NCHES	
DIM	MIN MAX		MIN	MAX	
Α		2.05		0.081	
A <sub>1</sub>	0.05	0.20	0.002	0.008	
b	0.35	0.50	0.014	0.020	
C	0.10	0.20	0.007	0.011	
D	9.90	10.50	0.390	0.413	
E	5.10	5.45	0.201	0.215	
е	1.27	BSC	0.050 BSC		
HE	7.40	8.20	0.291	0.323	
L	0.50	0.85	0.020	0.033	
LE	1.10	1.50	0.043	0.059	
Μ	0 °	10 °	0 °	10 °	
Q <sub>1</sub>	0.70	0.90	0.028	0.035	
Ζ		0.78		0.031	

CDIP-16 L SUFFIX CERAMIC DIP PACKAGE CASE 620A-01 **ISSUE O** 





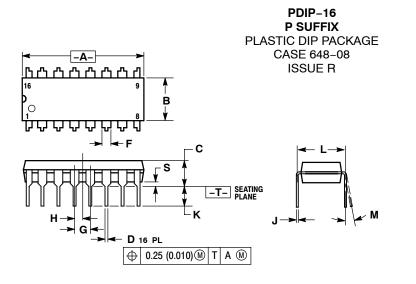
NOTES:

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- 1. DIMENSIONING AND TOLERANCING PER
- 2. 3.
- DIMENSIONING AND TOLEHANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: INCH. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC 4.
- BODY. THIS DRAWING REPLACES OBSOLETE CASE OUTLINE 620-10. 5

	INC	UEC	MILLIMETERS		
DIM	INCHES MIN MAX		MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С	0.200			5.08	
D	0.015 0.020		0.39	0.50	
Е	0.050 BSC		1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Η	0.008	0.015	0.21	0.38	
Κ	0.125	0.170	3.18	4.31	
L	0.300 BSC		7.62	BSC	
М	0 °	15 °	0 °	15 °	
Ν	0.020	0.040	0.51	1.01	

#### PACKAGE DIMENSIONS



NOTES:

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.

CONTROLLING DIMENSION: INCH.

DIMENSION L TO CENTER OF LEADS WHEN 3

FORMED PARALLEL DIMENSION B DOES NOT INCLUDE MOLD FLASH. ROUNDED CORNERS OPTIONAL. 5.

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100 BSC		2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
Μ	0 °	10 °	0 °	10 °	
S	0.020 0.040		0.51	1.01	

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